



Insulated Gate Bi-Polar Transistor Type T1600GB45G

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V _{CES}	Collector – emitter voltage	4500	V
V _{DC link}	Permanent DC voltage for 100 FIT failure rate.	2800	V
V _{GES}	Peak gate – emitter voltage	±20	V

	RATINGS	MAXIMUM LIMITS	UNITS
I _C	DC collector current, IGBT	1600	A
I _{CRM}	Repetitive peak collector current, t _p =1ms, IGBT	3200	A
I _{F(DC)}	Continuous DC forward current, Diode	1600	A
I _{FRM}	Repetitive peak forward current, t _p =1ms, Diode	3200	A
I _{FSM}	Peak non-repetitive surge t _p =10ms, V _{RM} =60%V _{RRM} , Diode (Note 4)	30	kA
I _{FSM2}	Peak non-repetitive surge t _p =10ms, V _{RM} ≤10V, Diode (Note 4)	33	kA
P _{MAX}	Maximum power dissipation, IGBT (Note 2)	12.8	kW
P _D	Maximum power dissipation, Diode (Note 2)	8.13	kW
(di/dt) _{cr}	Critical diode di/dt (note 3)	3000	A/μs
T _j	Operating temperature range.	-40 to +125	°C
T _{stg}	Storage temperature range.	-40 to +125	°C

Notes: -

- 1) Unless otherwise indicated T_j = 125°C.
- 2) T_{sink} = 25°C, double side cooled.
- 3) Maximum commutation loop inductance 200nH.
- 4) Half-sinewave, 125°C T_j initial.

Characteristics

IGBT Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
V _{CE(sat)}	Collector – emitter saturation voltage	-	2.75	3.2	I _C = 1600A, V _{GE} = 15V, T _j = 25°C	V
		-	3.50	3.9	I _C = 1600A, V _{GE} = 15V	V
V _{T0}	Threshold voltage	-	-	1.79	Current range: 530A – 1600A	V
r _T	Slope resistance	-	-	1.32		mΩ
V _{GE(TH)}	Gate threshold voltage	-	5.1	-	V _{CE} = V _{GE} , I _C = 170mA	V
I _{CES}	Collector – emitter cut-off current	-	45	70	V _{CE} = V _{CES} , V _{GE} = 0V	mA
I _{GES}	Gate leakage current	-	-	±20	V _{GE} = ±20V	μA
C _{ies}	Input capacitance	-	270	-	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz	nF
t _{d(on)}	Turn-on delay time	-	2.2	-	I _C = 1600A, V _{CE} = 2800V, di/dt = 2700A/μs V _{GE} = ±15V, L _S = 200nH R _{G(ON)} = 4.3Ω, R _{G(OFF)} = 12Ω, C _{GE} = 133nF Integral diode used as freewheel diode (Note 3 & 4)	μs
t _{r(V)}	Rise time	-	4.4	-		μs
Q _{g(on)}	Turn-on gate charge	-	9	-		μC
E _{on}	Turn-on energy	-	12	-		J
t _{d(off)}	Turn-off delay time	-	4.8	-		μs
t _{f(I)}	Fall time	-	2.6	-		μs
Q _{g(off)}	Turn-off gate charge	-	10	-		μC
E _{off}	Turn-off energy	-	8.7	-		J
I _{SC}	Short circuit current	-	5000	-		V _{GE} = +15V, V _{CC} = 2800V, V _{CEmax} ≤ V _{CES} , t _p ≤ 10μs

Diode Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
V _F	Forward voltage	-	3.3	3.6	I _F = 1600A, T _j = 25°C	V
		-	3.45	3.8	I _F = 1600A	V
V _{T0}	Threshold voltage	-	-	2.14	Current range 530A - 1600A	V
r _T	Slope resistance	-	-	1.04		mΩ
I _{rm}	Peak reverse recovery current	-	1270	-	I _F = 1600A, V _r = 2800V, V _{GE} = -15V, di/dt = 2700A/μs	A
Q _{rr}	Recovered charge	-	1960	-		μC
t _{rr}	Reverse recovery time, 50% chord	-	1.75	-		μs
E _r	Reverse recovery energy	-	2.03	-		J

Thermal Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
R _{thJK}	Thermal resistance junction to sink, IGBT	-	-	7.8	Double side cooled	K/kW
		-	-	12.8	Collector side cooled	K/kW
		-	-	20.3	Emitter side cooled	K/kW
R _{thJK}	Thermal resistance junction to sink, Diode	-	-	12.3	Double side cooled	K/kW
		-	-	19.5	Cathode side cooled	K/kW
		-	-	35.7	Anode side cooled	K/kW
F	Mounting force	50	-	70	Note 2	kN
W _t	Weight	-	2	-		kg

Notes:-

- 1) Unless otherwise indicated T_j = 125°C.
- 2) Consult application note 2008AN01 for detailed mounting requirements
- 3) C_{GE} is additional gate – emitter capacitance added to output of gate drive
- 4) Figures 4 to 10 are obtained using integral diode as freewheeling diode

Curves

Figure 1 – Typical collector-emitter saturation voltage characteristics

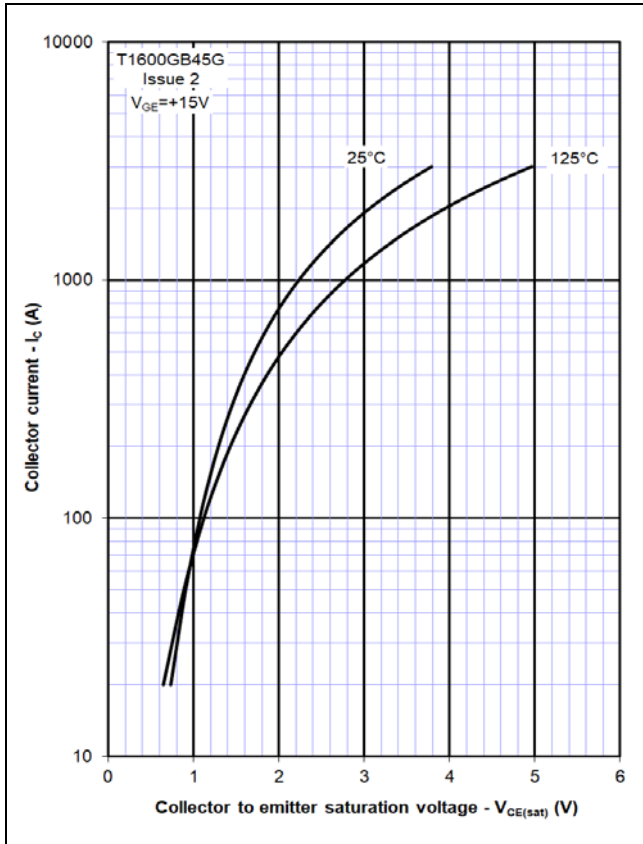


Figure 2 – Typical output characteristic

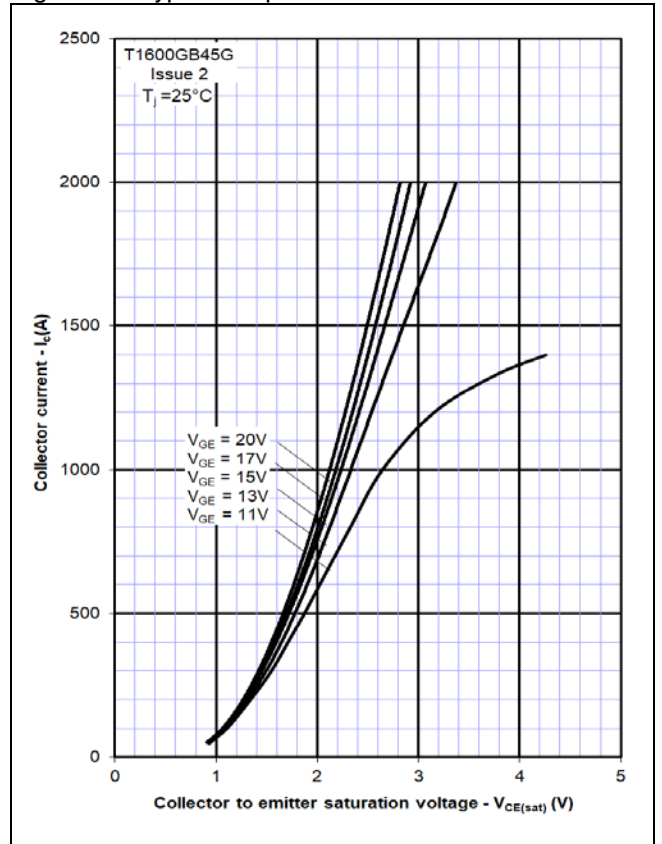


Figure 3 – Typical output characteristic

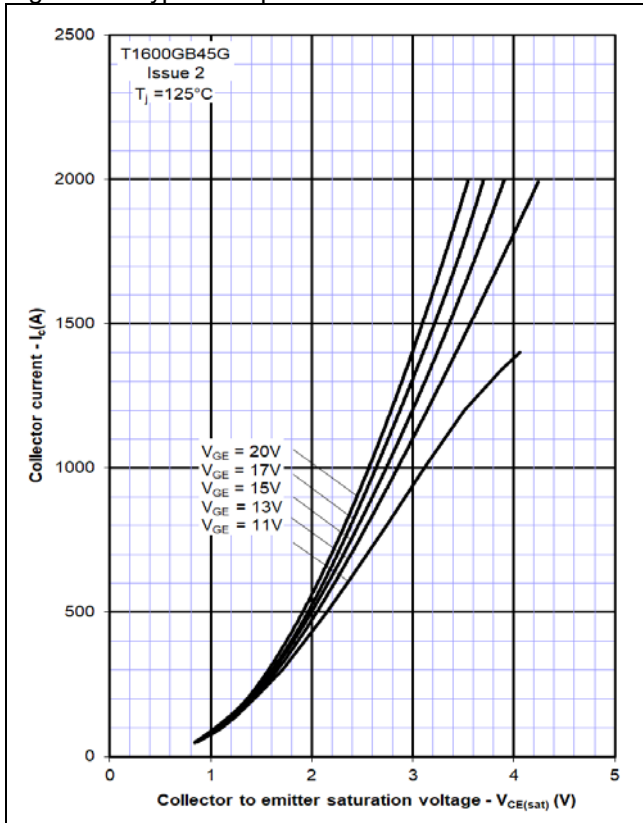


Figure 4 – Typical turn-on delay time vs gate resistance

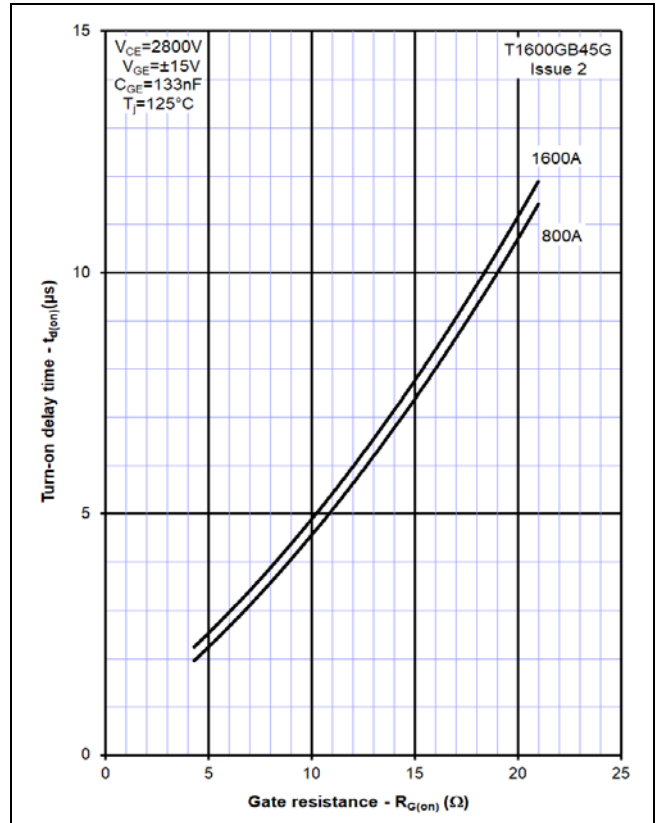


Figure 5 – Typical turn-off delay time vs. gate resistance

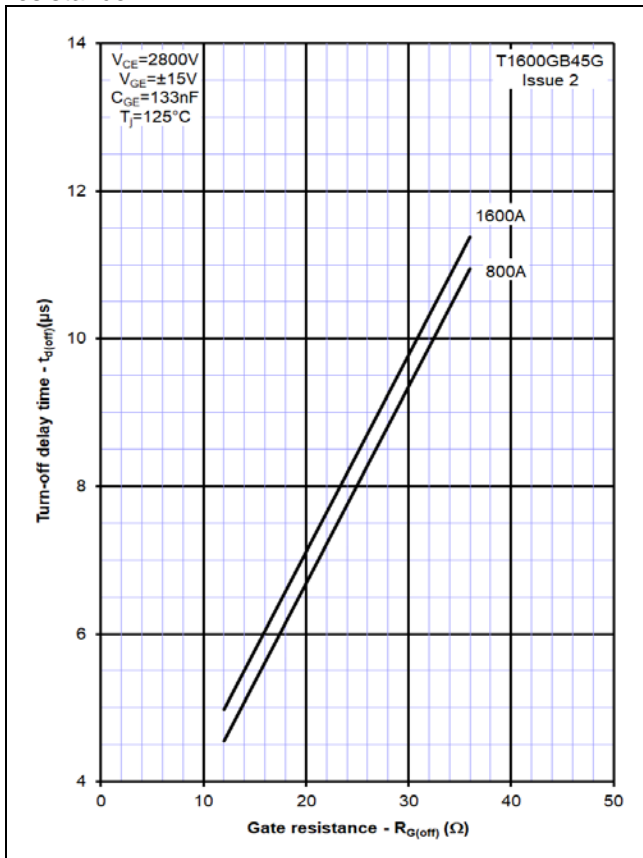


Figure 6 – Typical turn-on energy vs. collector current

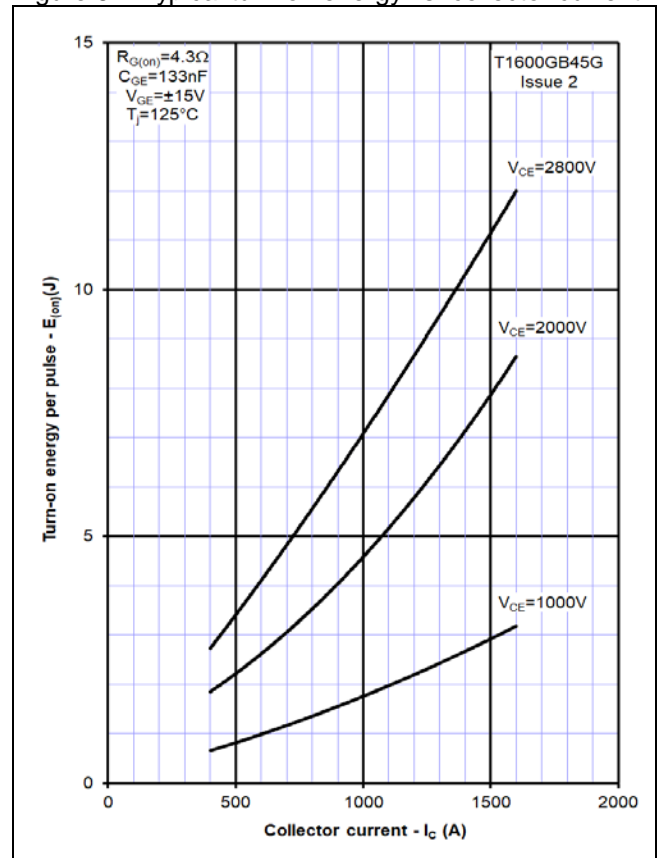


Figure 7 – Typical turn-on energy vs. di/dt

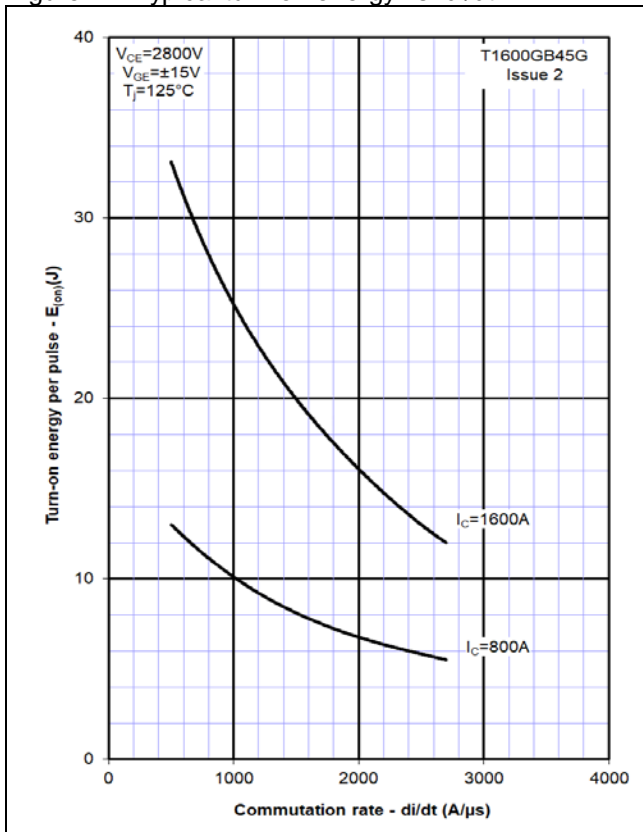


Figure 8 – Typical turn-off energy vs. collector current

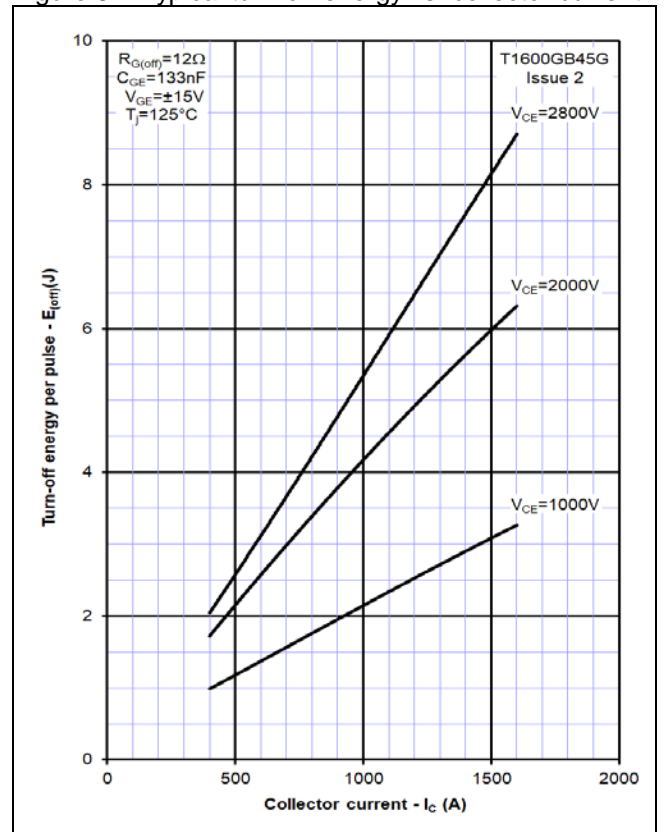


Figure 9 – Turn-off energy vs voltage

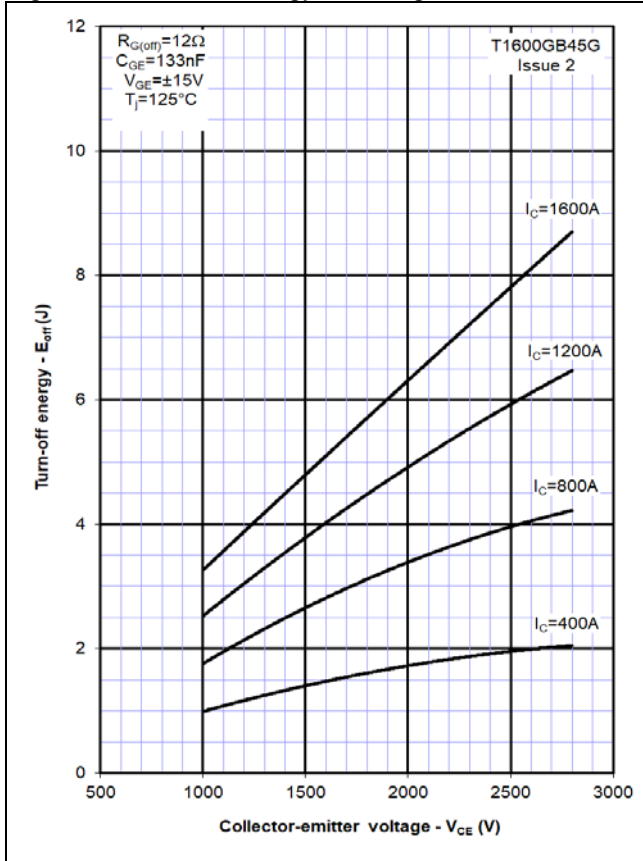


Figure 10 – Safe operating area (IGBT)

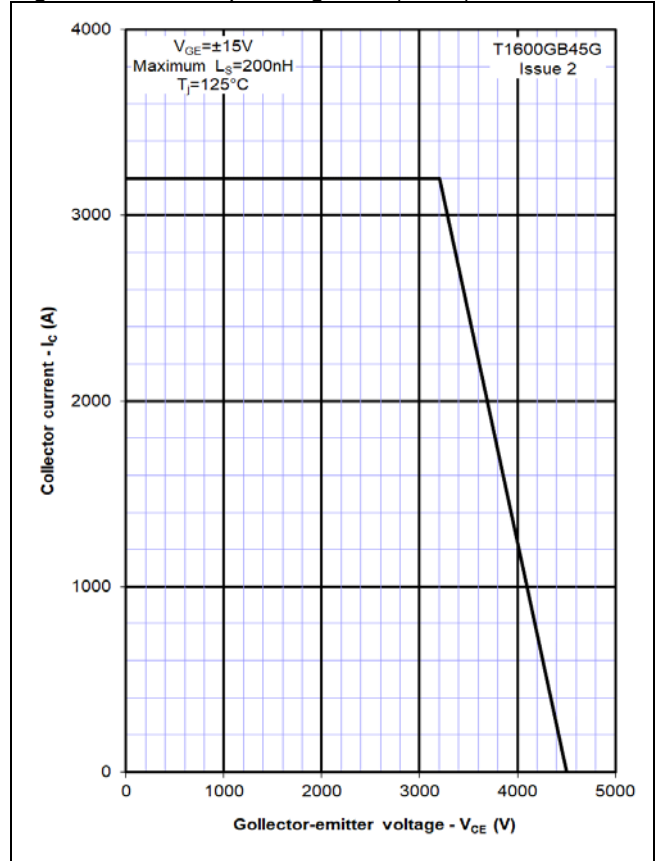


Figure 11 – Typical diode forward characteristics

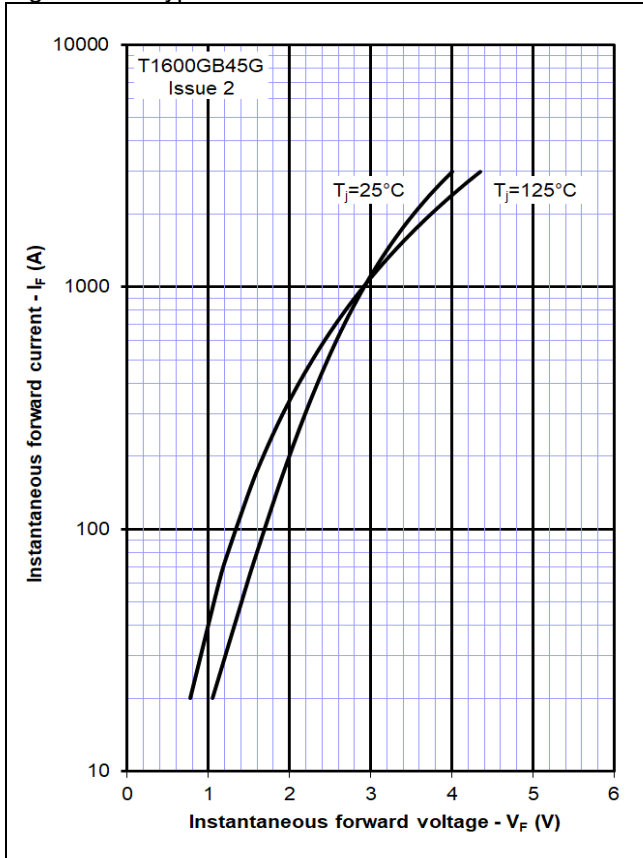


Figure 12 – Typical recovered charge

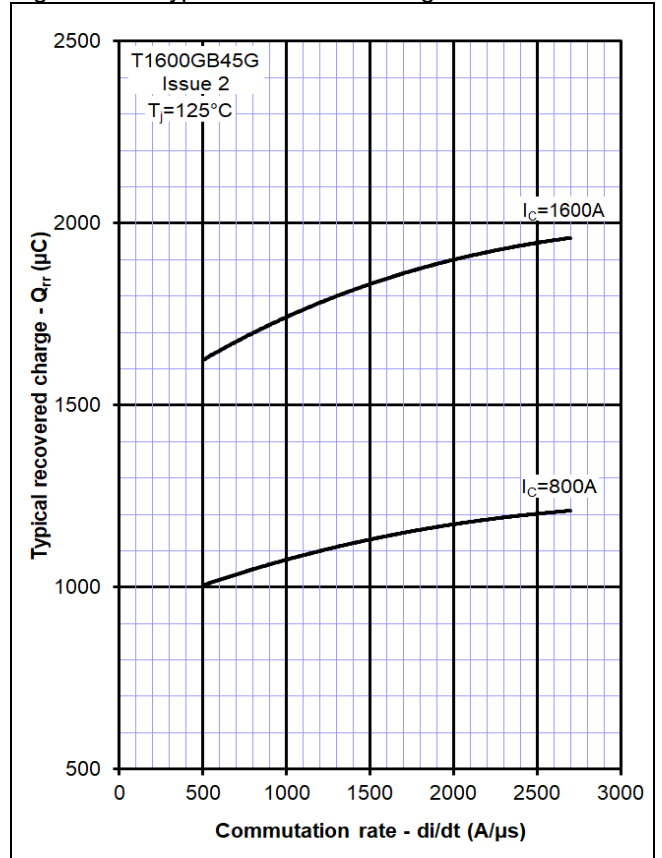


Figure 13 – Typical reverse recovery current

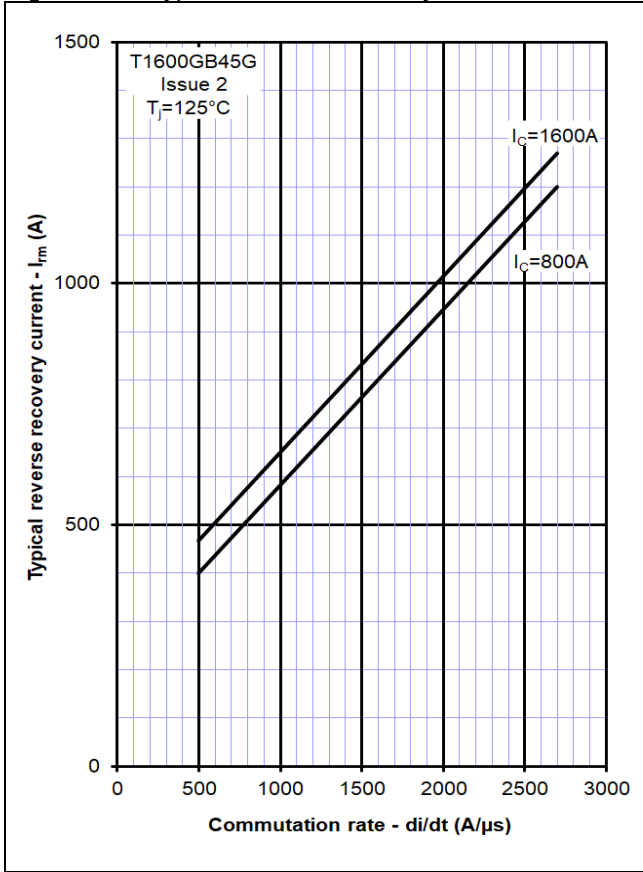


Figure 14 – Typical reverse recovery time

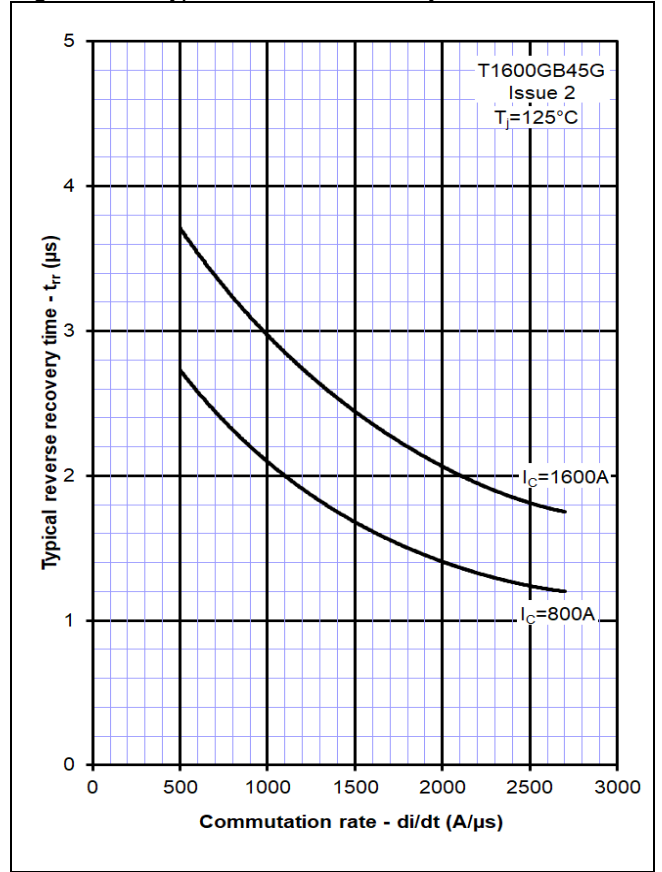


Figure 15 – Typical reverse recovery energy

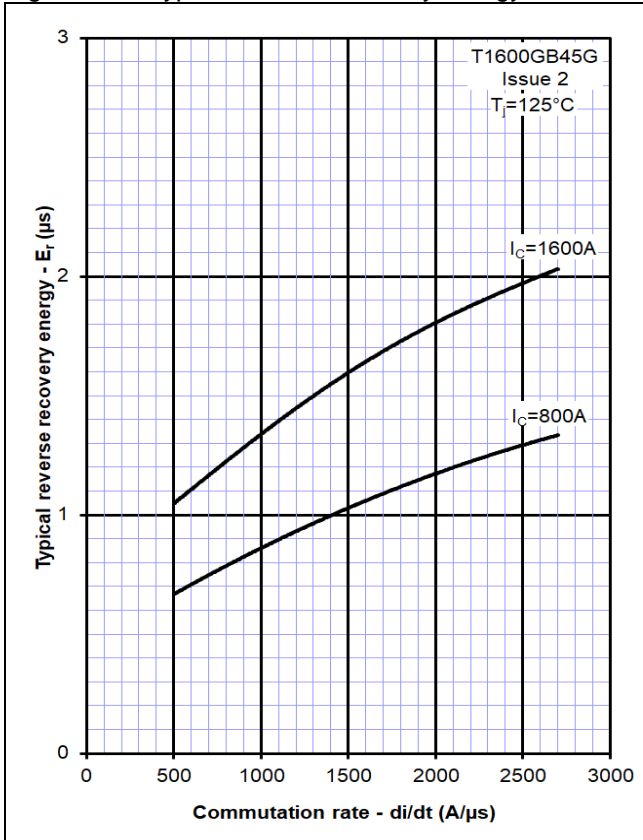


Figure 16 – Safe operating area (Diode)

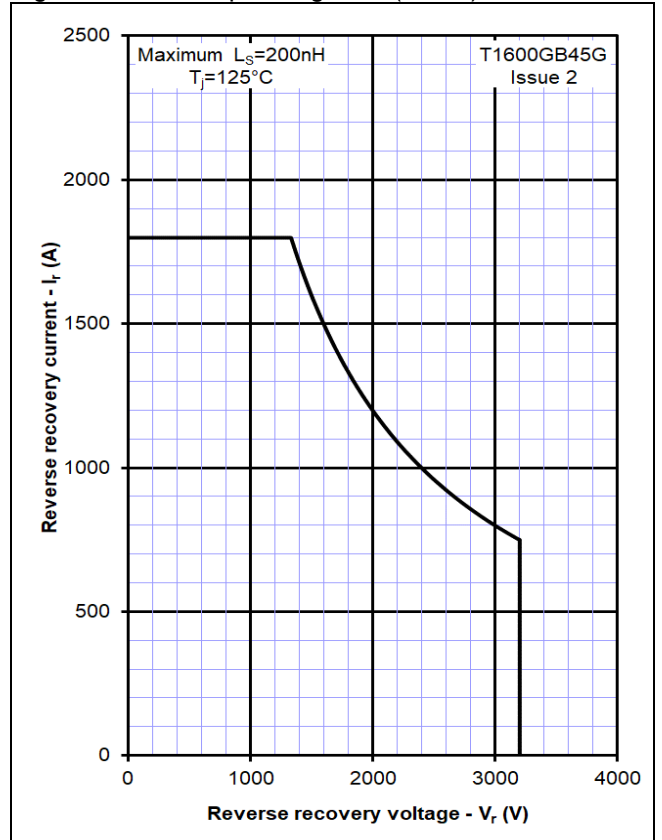


Figure 17 – Transient thermal impedance (IGBT)

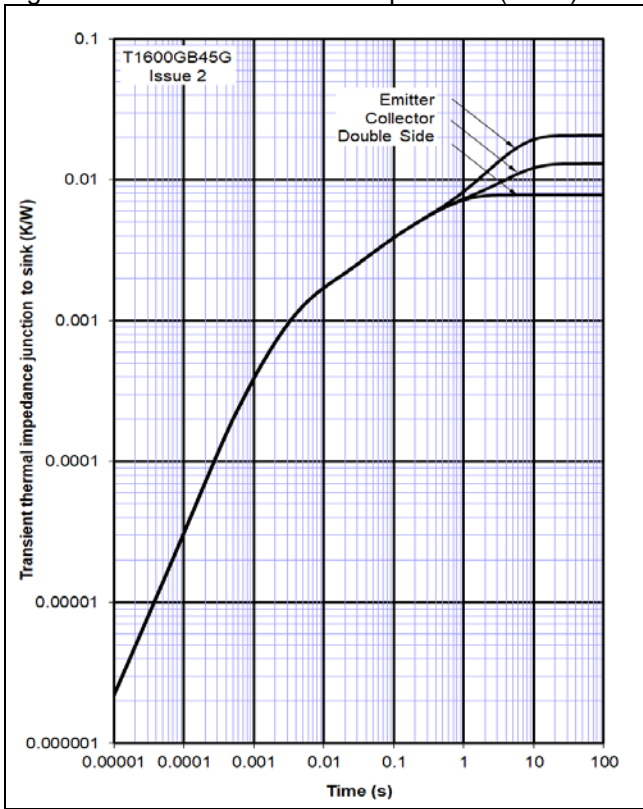
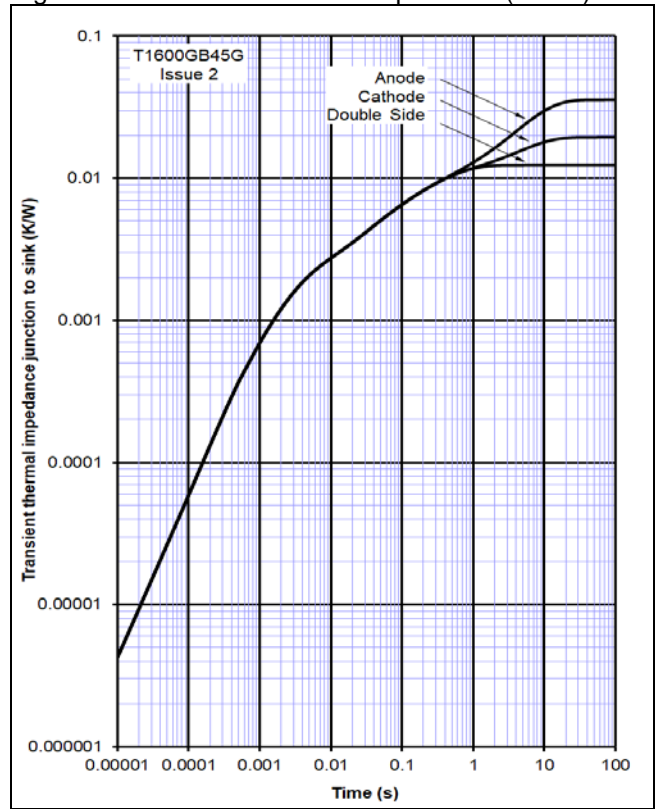
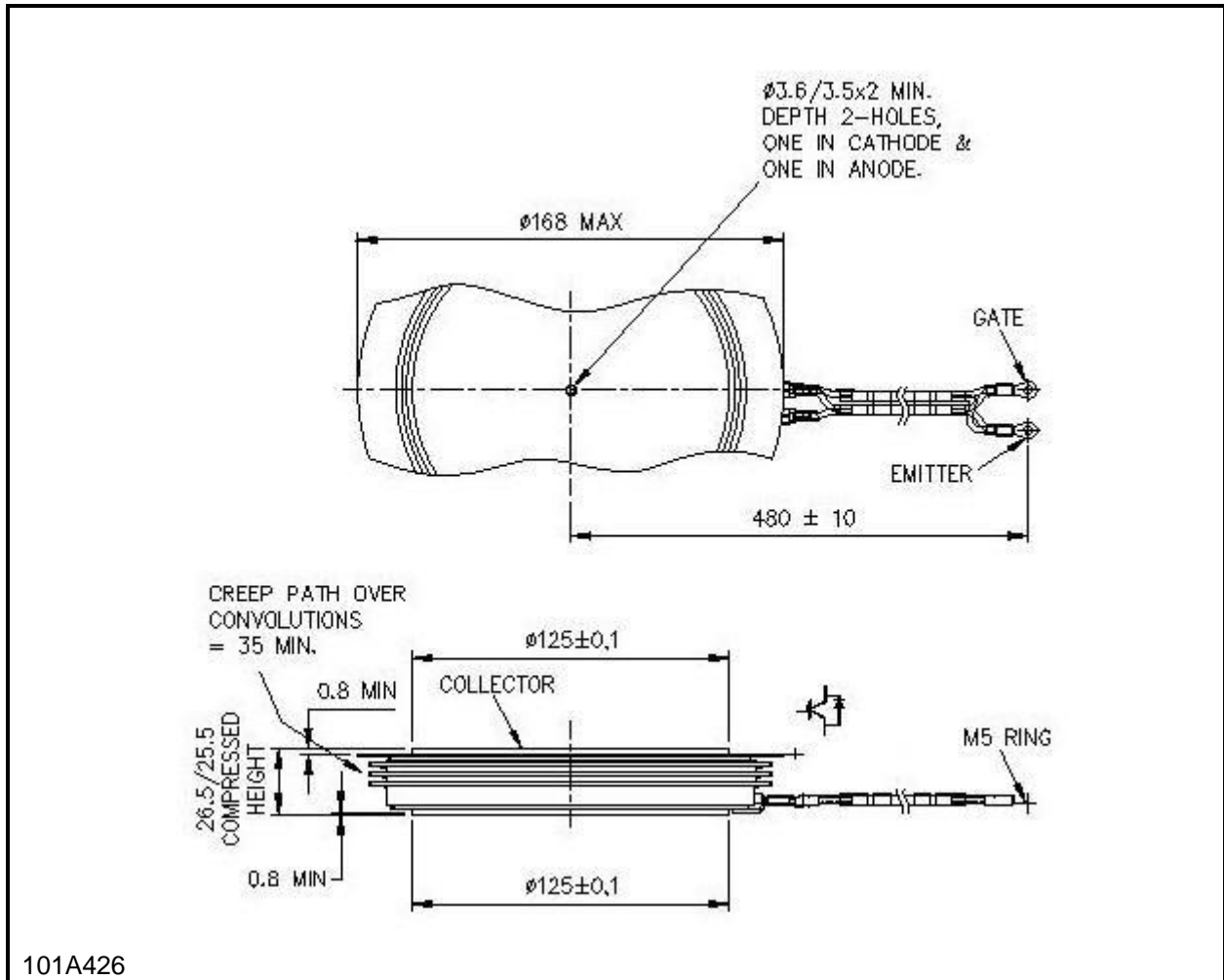


Figure 18 – Transient thermal impedance (Diode)



Outline Drawing & Ordering Information



ORDERING INFORMATION

(Please quote 10 digit code as below)

T1600	GB	45	G
Fixed type Code	Fixed Outline Code	Voltage Grade $V_{CES}/100$ 45	Fixed format code

 Typical order code: T1600GB45G ($V_{CES} = 4500V$)

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